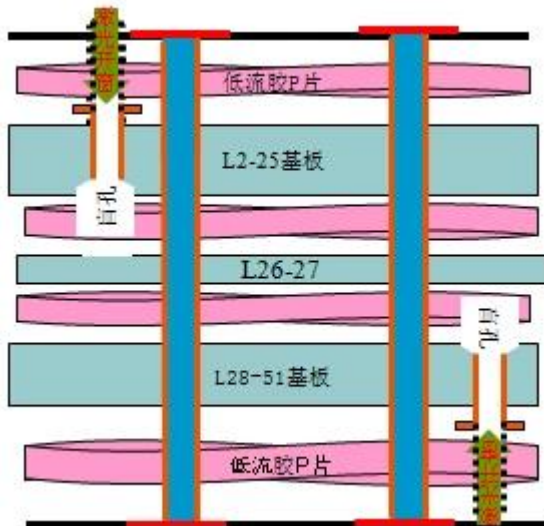


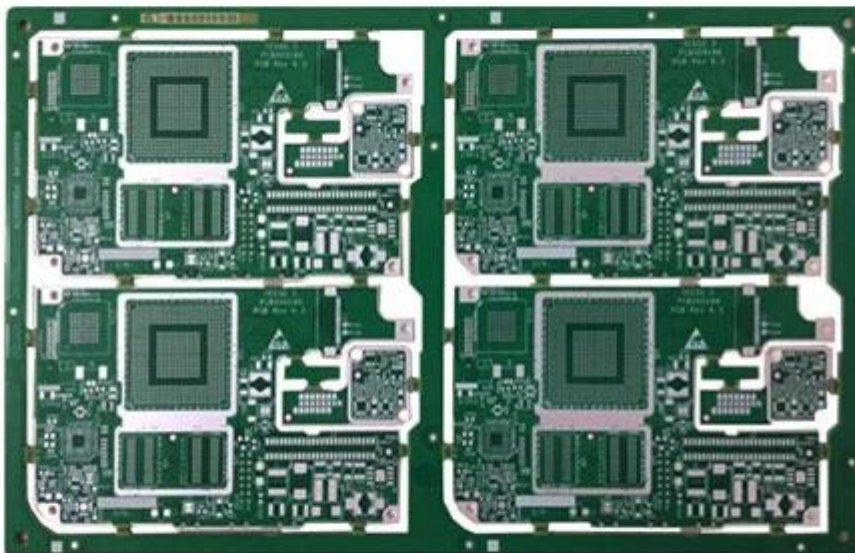
Copper Plate holes Minimum .025 AVG,. 020 min. Löcher dürfen nicht eingesteckt werden
Spezial-Anforderung: EniG, Impedanz: Tol: +/-7%, Taste fit Loch

Pack mit colorless transparent Bubble Film, 25 Stk/Tasche, Put desiccant in Flanke, Put feuchte Indikator-Karte auf der Oberseite

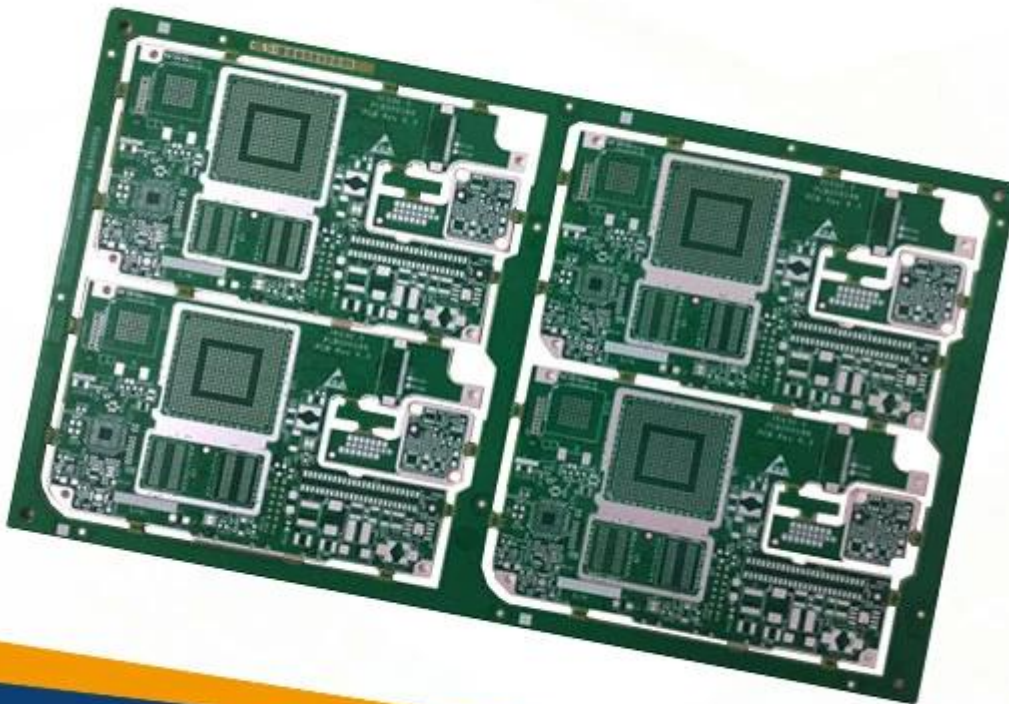
Layer-Struktur



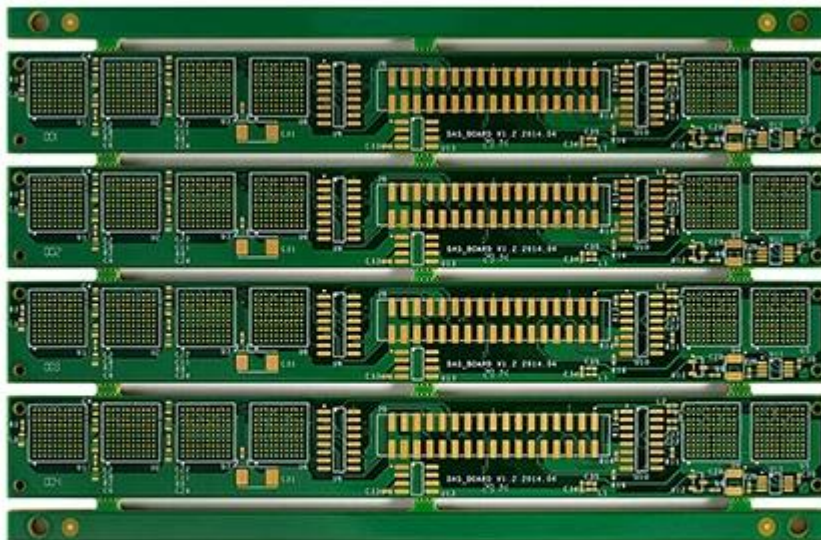
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